

# HAT2038R/HAT2038RJ

Silicon N Channel Power MOS FET  
High Speed Power Switching

## HITACHI

ADE-208-666C (Z)

4th. Edition

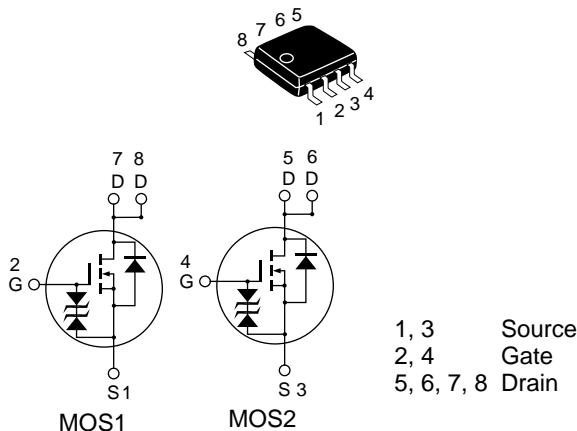
February 1999

### Features

- For Automotive Application ( at Type Code "J ")
- Low on-resistance
- Capable of 4 V gate drive
- High density mounting

### Outline

SOP-8



# HAT2038R/HAT2038RJ

## Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	60	V
Gate to source voltage	V <sub>GSS</sub>	± 20	V
Drain current	I <sub>D</sub>	5	A
Drain peak current	I <sub>D(pulse)</sub> <sup>Note1</sup>	40	A
Body-drain diode reverse drain current	I <sub>DR</sub>	5	A
Avalanche current	HAT2038R I <sub>AP</sub> <sup>Note4</sup>	—	—
	HAT2038RJ	5	A
Avalanche energy	HAT2038R E <sub>AR</sub> <sup>Note4</sup>	—	—
	HAT2038RJ	2.14	mJ
Channel dissipation	Pch <sup>Note2</sup>	2	W
Channel dissipation	Pch <sup>Note3</sup>	3	W
Channel temperature	T <sub>ch</sub>	150	°C
Storage temperature	T <sub>stg</sub>	– 55 to + 150	°C

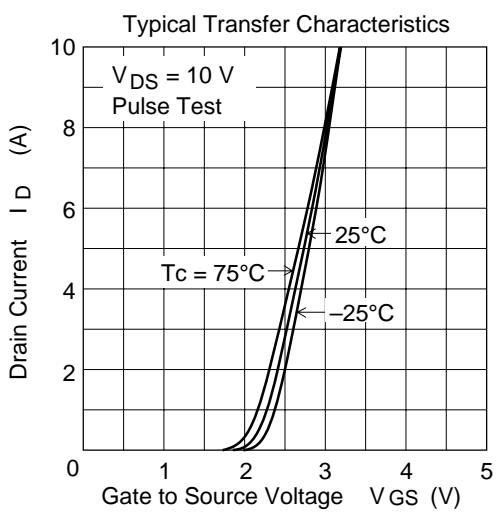
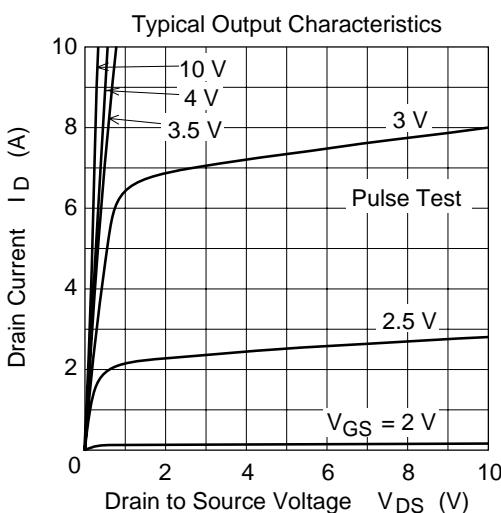
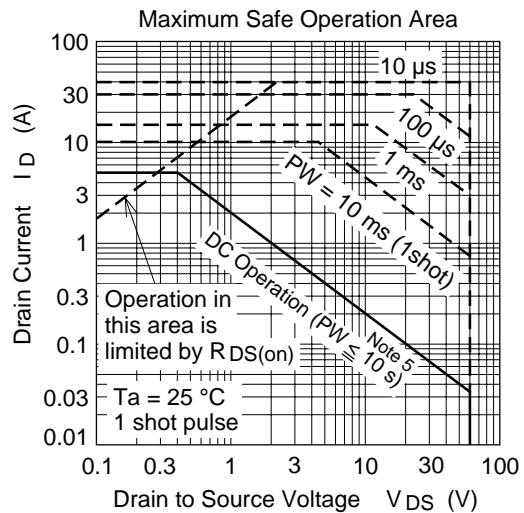
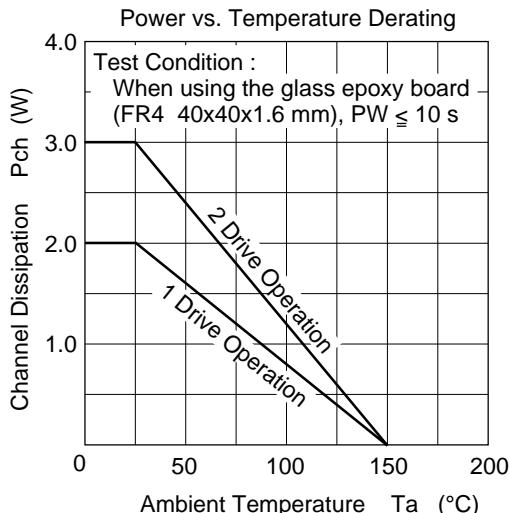
- Note:
1. PW ≤ 10μs, duty cycle ≤ 1 %
  2. 1 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW≤ 10s
  3. 2 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW≤ 10s
  4. Value at T<sub>ch</sub>=25°C, R<sub>g</sub>≥50Ω

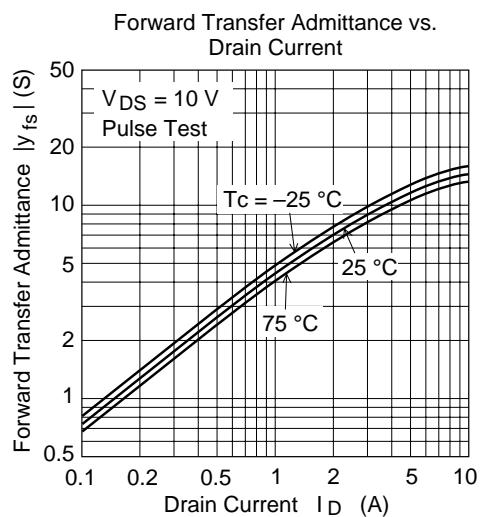
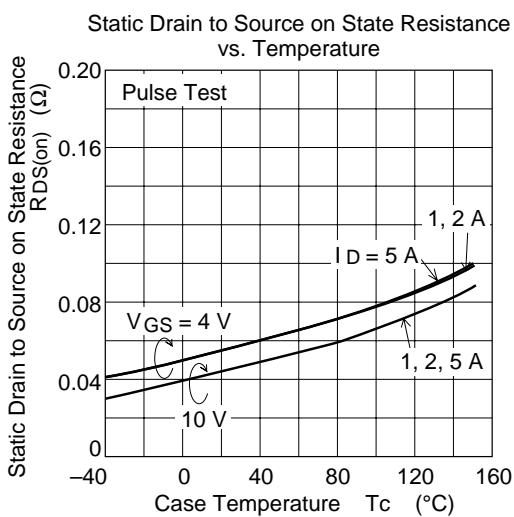
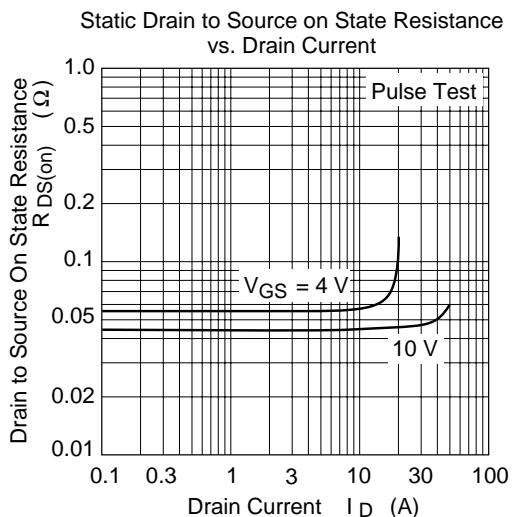
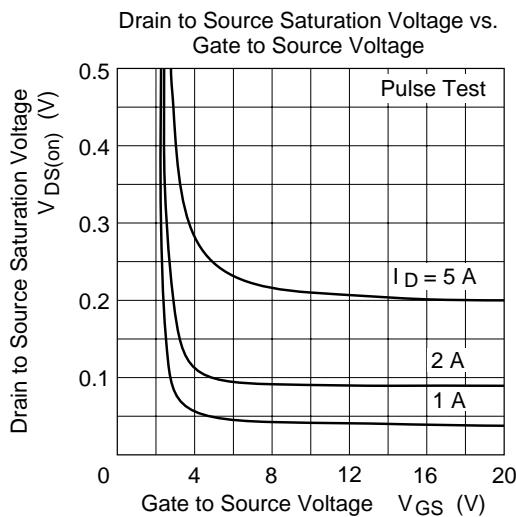
## Electrical Characteristics (Ta = 25°C)

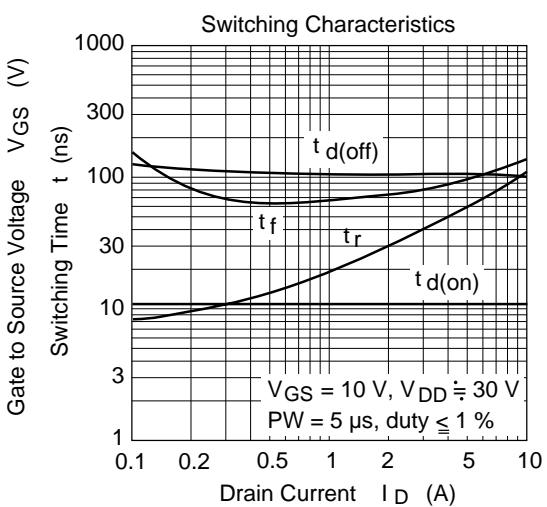
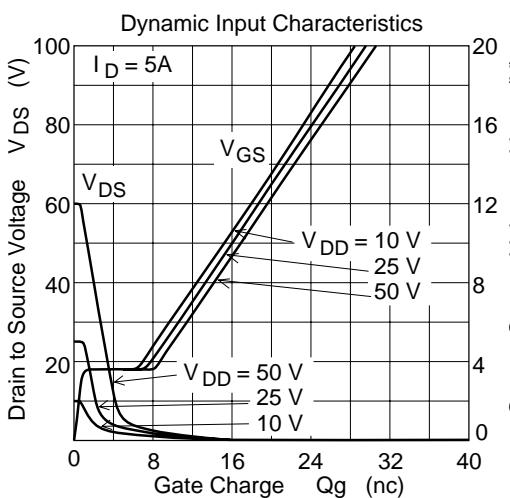
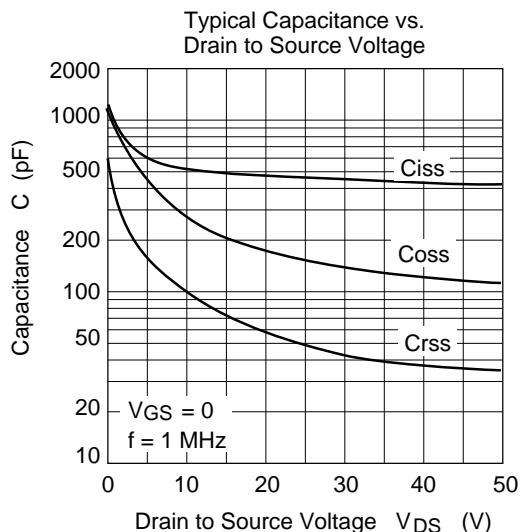
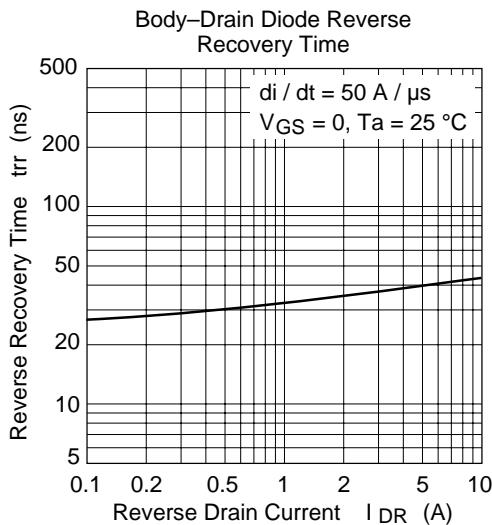
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	60	—	—	V	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	± 20	—	—	V	I <sub>G</sub> = ± 100 μA, V <sub>DS</sub> = 0
Gate to source leak current	I <sub>GSS</sub>	—	—	± 10	μA	V <sub>GS</sub> = ± 16 V, V <sub>DS</sub> = 0
Zero gate voltage HAT2038R	I <sub>DSS</sub>	—	—	1	μA	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0
drain current HAT2038RJ	I <sub>DSS</sub>	—	—	0.1	μA	
Zero gate voltage HAT2038R	I <sub>DSS</sub>	—	—	—	μA	V <sub>DS</sub> = 48 V, V <sub>GS</sub> = 0
drain current HAT2038RJ	I <sub>DSS</sub>	—	—	10	μA	Ta = 125°C
Gate to source cutoff voltage	V <sub>GS(off)</sub>	1.2	—	2.2	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Static drain to source on state resistance	R <sub>DS(on)</sub>	—	0.043	0.058	Ω	I <sub>D</sub> = 3 A, V <sub>GS</sub> = 10 V <sup>Note5</sup>
Forward transfer admittance	y <sub>fs</sub>	6	9	—	S	I <sub>D</sub> = 3 A, V <sub>DS</sub> = 10 V <sup>Note5</sup>
Input capacitance	C <sub>iss</sub>	—	520	—	pF	V <sub>DS</sub> = 10 V
Output capacitance	C <sub>oss</sub>	—	270	—	pF	V <sub>GS</sub> = 0
Reverse transfer capacitance	C <sub>rss</sub>	—	100	—	pF	f = 1MHz
Turn-on delay time	t <sub>d(on)</sub>	—	11	—	ns	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3 A
Rise time	t <sub>r</sub>	—	40	—	ns	V <sub>DD</sub> ≈ 30 V
Turn-off delay time	t <sub>d(off)</sub>	—	110	—	ns	
Fall time	t <sub>f</sub>	—	80	—	ns	
Body-drain diode forward voltage	V <sub>DF</sub>	—	0.84	1.1	V	IF = 5 A, V <sub>GS</sub> = 0 <sup>Note5</sup>
Body-drain diode reverse recovery time	t <sub>rr</sub>	—	40	—	ns	IF = 5 A, V <sub>GS</sub> = 0 dI/F / dt = 50 A/μs

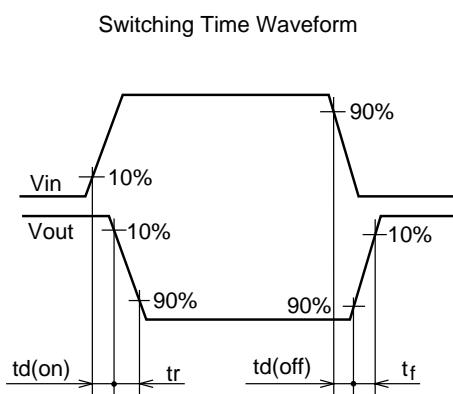
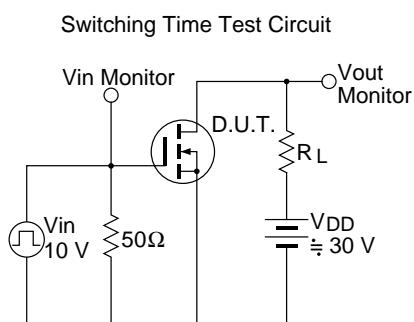
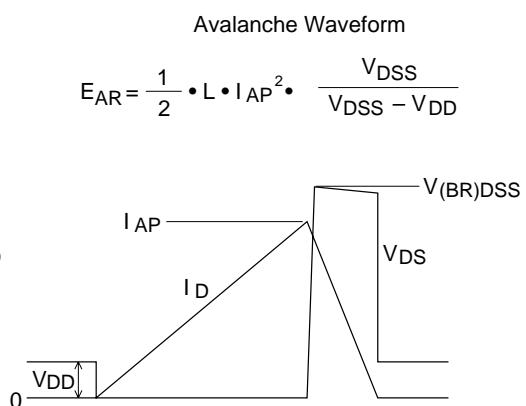
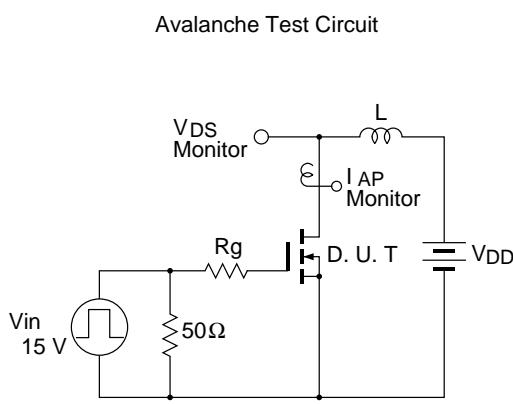
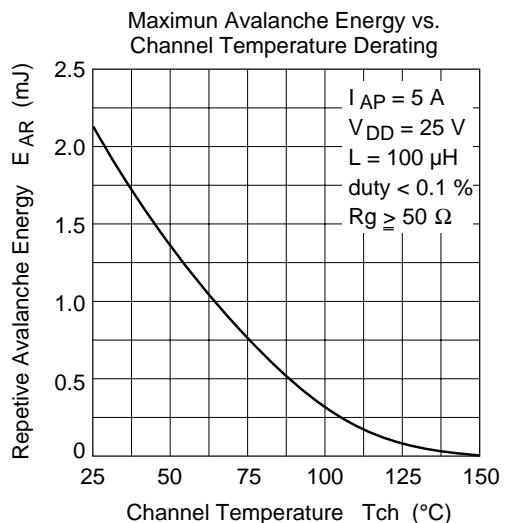
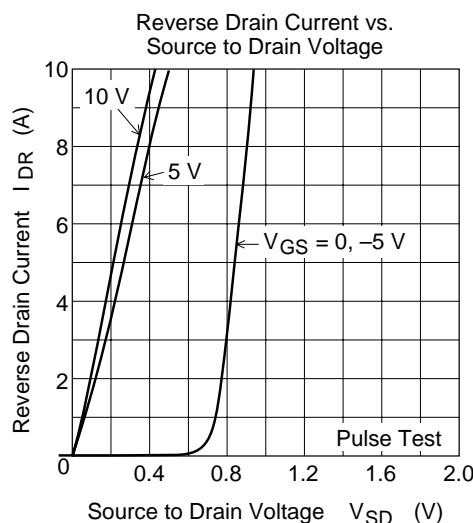
Note: 5. Pulse test

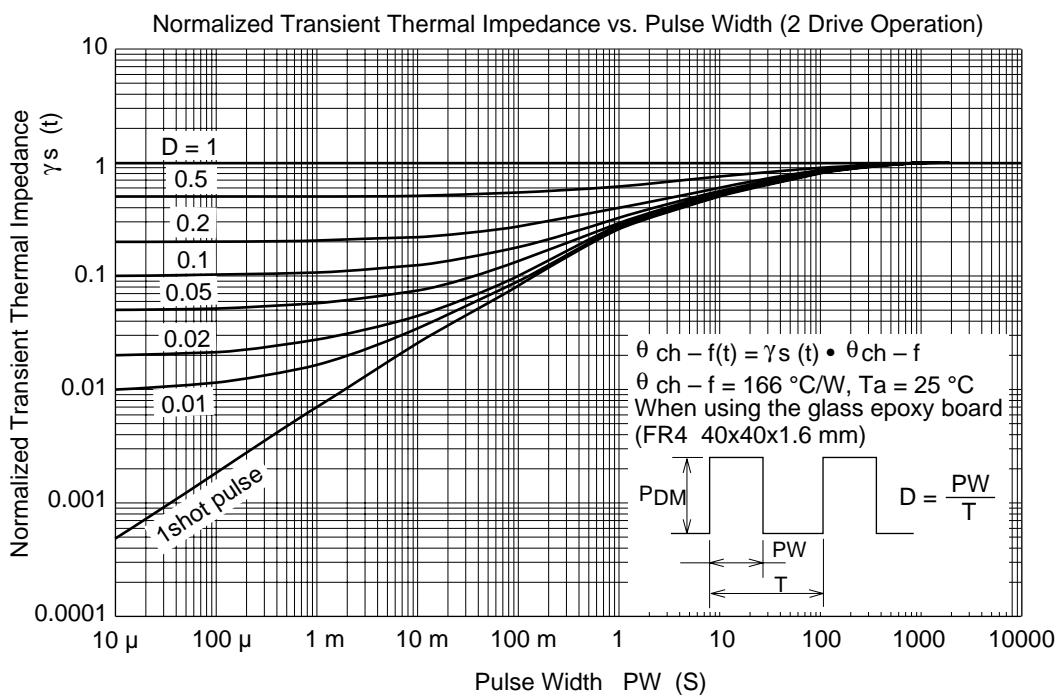
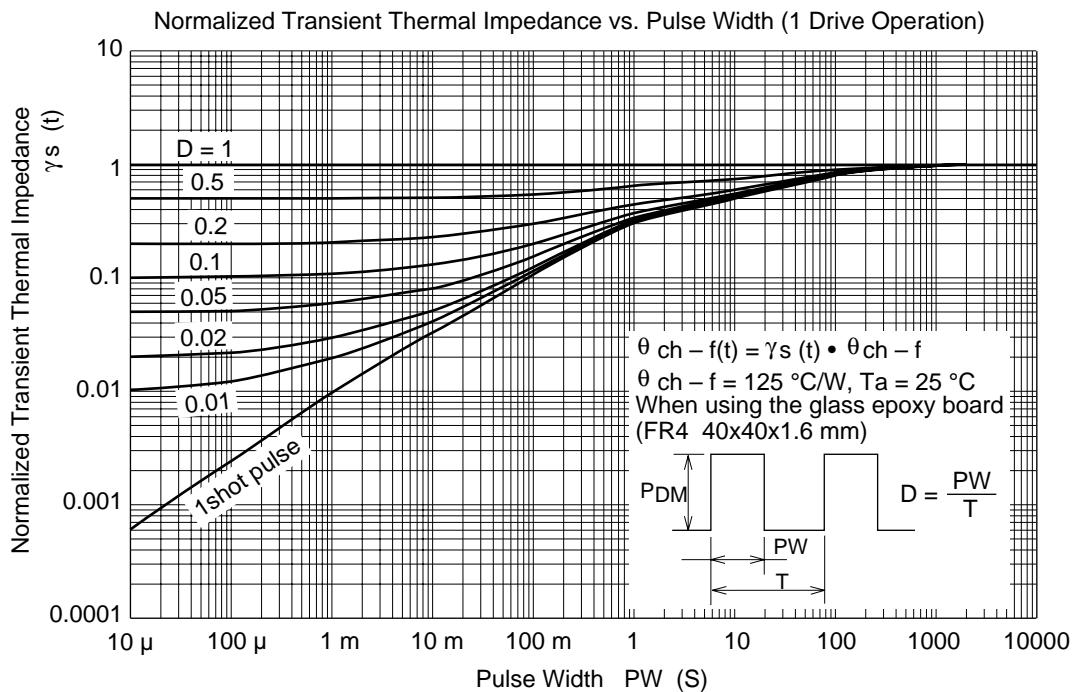
## Main Characteristics





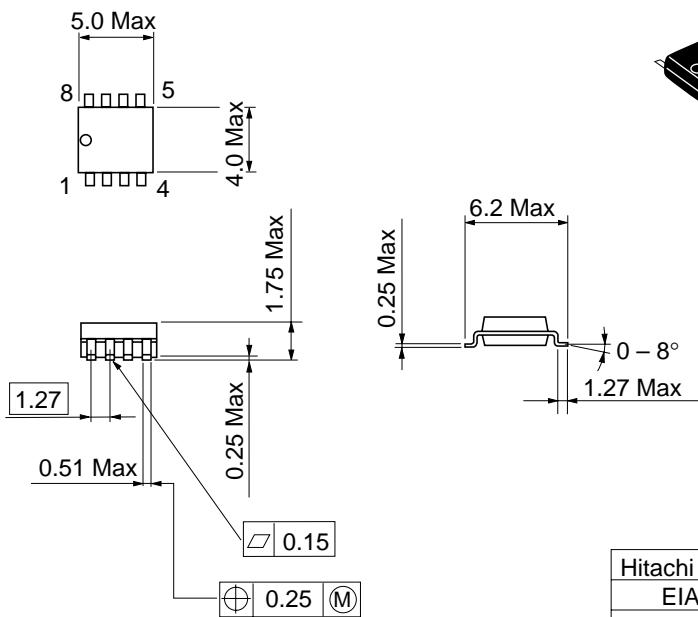






**Package Dimensions**

Unit: mm



Hitachi code	FP-8DA
EIAJ	—
JEDEC	MS-012AA

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